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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/891,511	06/27/2001	Mamoru Nakasuji	010819	8779
38834	7590 09/30/2004		EXAMINER	
WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP 1250 CONNECTICUT AVENUE, NW			BERMAN, JACK I	
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SUITE 700			ART UNIT	PAPER NUMBER
WASHINGTON, DC 20036			2881	

DATE MAILED: 09/30/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)				
Office Action Summan	09/891,511	NAKASUJI ET AL.				
Office Action Summary	Examiner	Art Unit				
	Jack I. Berman	2881				
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the d	correspondence address				
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	I36(a). In no event, however, may a reply be tir ly within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from e, cause the application to become ABANDONE	nely filed /s will be considered timely. the mailing date of this communication. ED (35 U.S.C. § 133).				
Status						
1)⊠ Responsive to communication(s) filed on 09 S	September 2004.					
	s action is non-final.					
3) Since this application is in condition for allowa	, _					
closed in accordance with the practice under E	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims						
4) ⊠ Claim(s) 17-59 and 61-71 is/are pending in the 4a) Of the above claim(s) 17-59 is/are withdray 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 61-71 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and/or	wn from consideration.					
Application Papers						
9) ☐ The specification is objected to by the Examine 10) ☑ The drawing(s) filed on 22 October 2001 is/are Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) ☐ The oath or declaration is objected to by the Example 11.	e: a)⊠ accepted or b)⊡ objected drawing(s) be held in abeyance. Se tion is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the prio application from the International Burea * See the attached detailed Office action for a list	ts have been received. ts have been received in Applicat ority documents have been receive u (PCT Rule 17.2(a)).	ion No ed in this National Stage				
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:					

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claim 64 is rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 5,665,968 to Meisburger et al. in view of U.S. Patent No. 5,973,323 to Adler et al. Meisburger et al. discloses an inspecting apparatus for inspecting an object to be inspected by irradiating charged particles onto said object to be inspected, said apparatus comprising: a working chamber for inspecting said object to be inspected, said chamber capable of being controlled to have a vacuum atmosphere (see the section labeled VACUUM SYSTEM beginning at line 52 in column 19); a beam generating means for generating said charged particles as a beam (see lines 14-23 in column 9); an electron optical system for guiding and irradiating said beam onto said object to be inspected held in said working chamber, detecting secondary charged particles emanated from said object to be inspected and introducing said secondary charged particles to an image processing system (see lines 23-64 in column 9); said image processing system for forming an

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image by said secondary charged particles (see sections labeled VIDEO FRAME BUFFER and IMAGE DISPLAY in column 18); a data processing system for displaying and/or storing status information of said object to be inspected based on output from said image processing system (see the sections labeled DEFECT PROCESSOR in column 14 and POST PROCESSOR in column 18); a stage device (24) for operatively holding said object to be inspected so as to be movable with respect to said beam; a carrying mechanism for securely accommodating said object to be inspected and for transferring said object to or from said working chamber (see sections labeled SUBSTRATE HANDLER in column 19 and LOAD OPERATION starting in column 20); an alignment controller for observing the surface of said object to be inspected for the alignment of said object to be inspected with respect to said electron-optical system to control the alignment (see section labeled OPTICAL ALIGNMENT SYSTEM in column 21) wherein the alignment of said object to be inspected includes rough alignment; an E x B separator (Wien filter deflectors 112 and 113), having an electric field and a magnetic field crossing at right angles and including at least a pair of electrodes for generating the electric field and a pair of electrodes for generating the magnetic field. While Meisburger et al. uses a CCD camera with different magnifications for the rough alignment of the object to be inspected before a high magnification alignment for inspection is made by the electron optical system, the substitution of an optical microscope for the CCD camera would have been an obvious substitution of known equivalents. Meisburger et al. uses a single focused electron beam and a single electron detector to inspect an object. Adler et al., on the other hand, teaches that objects can be inspected more rapidly by irradiating the object with an area-beam and using a TDI image sensor (19). It would have been obvious to a person having ordinary skill in the art to use the

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Adler et al. area-beam and TDI image sensor in the Meisburger et al. system in order to achieve the faster inspecting described by Adler et al.

Claims 65 and 66 are rejected under 35 U.S.C. 103(a) as being unpatentable over

Meisburger et al. and Adler et al. as applied to claim 64 above, and further in view of U.S. Patent
No. 5,944,049 to Beyer et al. In the section labeled VACUUM SYSTEM, Meisburger et al.

teaches to monitor the vacuum level in the working chamber and to provide an interlock
mechanism (pressure sensors, computers 42 and 46, and pneumatic isolation valve 145) that
executes an emergency control to secure the vacuum level at a safe level in the case of an
irregularity. Beyer et al. teaches, at lines 6-19 in column 1, that it is known in the art to use a
turbo molecular pump as a main exhaust pump (2) and a roots vacuum pump (3) as a roughing
vacuum pump to exhaust a vacuum chamber of the type used for processing semiconductor
devices. It would have been obvious to a person having ordinary skill in the art to use this known
vacuum exhausting system to perform the required exhausting of the working chamber in the
Meisburger et al./Adler et al. system discussed above. Use of this known exhausting system
instead of the turbopump used by Meisburger et al. would have been an obvious substitution of
known equivalents.

Claims 61 and 62 are rejected under 35 U.S.C. 103(a) as being unpatentable over Meisburger et al. and Adler et al. as applied to claim 64 above, and further in view of U.S. Patent No. 6,315,512 to Tabrizi et al. and U.S. Patent No. 5,536,128 to Shimoyashiro et al. At lines 59-65 in column 9, Tabrizi et al. teaches to provide a mini-environment chamber (604) for supplying a clean gas to an object to be introduced into a working chamber to prevent dust from contacting the object, the mini-environment chamber including a gas supply unit including a

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cleaning filter such as a HEPA or ULPA filter for creating the clean gas, a loading chamber (load locks 406a and 406b) disposed between said mini-environment chamber and the working chamber (process chamber 410), and adapted to be independently controllable so as to have a vacuum atmosphere, a loader having a carrier unit (atmospheric robot 404) capable of transferring the object between the mini-environment chamber and a loading chamber, and another carrier unit (vacuum transport robot 422) capable of transferring said object between said loading chamber and said working chamber. Tabrizi et al. does not describe the minienvironment chamber in detail, but does say at lines 39-44 in column 1 that such minienvironments may incorporate laminar gas flow. Shimoyashiro et al. discloses, at line 61 in column 9 through line 9 in column 10, that such mini-environments (clean box 50) may have downward laminar flows. It would have been obvious to a person having ordinary skill in the art to use the Tabrizi et al. loading system with the Shimoyashiro et al. mini-environment chamber to load the object to be inspected into the Meisburger et al./Adler et al. inspection system discussed above in order to avoid the contamination problem discussed by Tabrizi et al. and Shimoyashiro et al.

Claims 63, 67, and 71 are rejected under 35 U.S.C. 103(a) as being unpatentable over Meisburger et al., Adler et al., Tabrizi et al., and Shimoyashiro et al. as applied to claims 61 and 62 above, and further in view of Beyer et al. as applied to claims 65 and 66 above.

Claim 68 is rejected under 35 U.S.C. 103(a) as being unpatentable over Meisburger et al., Adler et al., Tabrizi et al., and Shimoyashiro et al., and Beyer et al. as applied to claims 63, 67, and 71 above, and further in view of U.S. Patent No. 4,911,103 to Davis et al. While applicant is correct in arguing that Davis et al.'s load lock chamber (12) is not equivalent to the mini-

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environment chamber between the ambient environment and a loading chamber, Davis et al. does discuss the problem of contaminants that may be introduced into a vacuum chamber and teaches, at lines 10-24 in column 24, to provide a particulate sensor to monitor the cleanliness of a loading chamber. It would have been obvious to a person having ordinary skill in the art to incorporate such a sensor in the Tabrizi et al./Shimoyashiro et al. mini-environment chamber discussed above and shut down the inspection apparatus when the cleanliness of the mini-environment chamber is below a predetermined level since these references both recognize the problems caused by contamination and seek to avoid these problems.

Claim 69 is rejected under 35 U.S.C. 103(a) as being unpatentable over Meisburger et al., Adler et al., Tabrizi et al., and Shimoyashiro et al., and Beyer et al. as applied to claims 63, 67, and 71 above, and further in view of U.S. Patent No. 6,344,750 to Lo et al. Lo et al. discloses scanning electron beam inspection apparatus similar to Meisburger et al.'s. At lines 37-55 in column 6, Lo et al. discloses a precharge unit comprising a charged particle irradiating section (36) for irradiating low voltage electrons in advance against said inspecting region just before the inspection and, beginning at line 48 in column 9, explains in detail how precharging removes variations of charge accumulated on an object under test. It would have been obvious to a person having ordinary skill in the art to apply this teaching of Lo et al.'s to the Meisburger et al./Adler et al./Tabrizi et al./Shimoyashiro et al./Beyer et al. apparatus discussed above by providing Lo et al.'s charged particle irradiating section in order to prevent the problems discussed by Lo et al. Claim 69 is rejected under 35 U.S.C. 103(a) as being unpatentable over Meisburger et al., Adler et al., Tabrizi et al., and Shimoyashiro et al., and Beyer et al. as applied to claims 63, 67, and 71 above, and further in view of U.S. Patent No. 4,607,167 to Petric and U.S. Patent No. Bisschops

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et al. Petric discloses a stage (30) for holding an object to be irradiated with a focused electron beam with a degree of freedom at least equal to or more than two with respect to the electronoptical system, said stage (30) comprising a non-contact supporting mechanism by means of static pressure bearings (see lines 10-15 in column 8), and a vacuum sealing mechanism (20) through differential pumping. It would have been obvious to a person having ordinary skill in the art to use the Petric apparatus as the stage positioning equipment and evacuation devices required for the Meisburger et al./Adler et al./Tabrizi et al./Shimoyashiro et al./Beyer et al. apparatus discussed above since the Petric apparatus is designed to permit the irradiation of objects with a focused electron beam of the type used by Meisburger et al. As can be best seen in Figure 4, Bisschops et al. teaches that when a static pressure bearing (21) is used to support a stage (14) that supports a wafer (W) inside the vacuum chamber (V) of a lithography system (2), it is advantageous to provide a partition (sliding seal plate 12) near the pressure bearing to minimize loss of vacuum. Since the Petric apparatus uses a pressure bearing as well as a partition near the electron beam generator, it would have been obvious to a person having ordinary skill in the art to apply the teachings of Bisschops et al. by providing an additional partition near the pressure bearing if the Petric apparatus is used as the stage in the Meisburger et al./Adler et al./Tabrizi et al./Shimoyashiro et al./Beyer et al. apparatus discussed above in order to maintain the lowest pressure possible at the surface of the wafer under test.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jack I. Berman whose telephone number is (571) 272-2468. The examiner can normally be reached on M-F (8:30-6:00) with every second Friday off.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, John R. Lee can be reached on (571) 272-2477. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jack I. Berman
Primary Examiner
Art Unit 2881

jb 9/29/04